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PATENT

Docket No. JCLA7749

Date: 11-21-2001

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ASSISTANT COMMISSIONER FOR PATENTS
WASHINGTON, D.C. 20231
ATTENTION: APPLICATION BRANCH

Sir:

Transmitted herewith for filing is the patent application of

Inventors: James Seng-Ju Ni

For: CIRCUIT TRIMMING OF PACKAGED IC CHIP

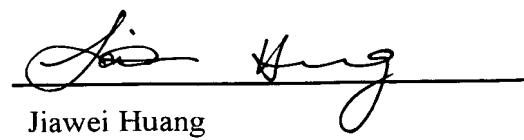
Enclosed are:

- Specification 14 pages.
- 3 Sheets of drawings
- Recordation Form Cover sheet with 2 pages assignment.
- A certified copy of Taiwan Patent Application No. dated
- SIGNED** declaration and power of attorney.
- Return Prepaid postcard.

CLAIMS AS FILED

FOR	NUMBER FILED	NUMBER EXTRA	RATE	FEE
Basic Fee			\$370.00	\$370.00
Total Claims	20	— 20 = 0	\$9.00	\$0.00
Independent Claims	4	— 3 = 1	\$42.00	\$42.00
If application contains any multiple dependent claim (s), then add			\$140.00	\$0.00
	TOTAL FILING FEE			\$412.00

- A check in the amount of \$412.00 cover the filing fee is enclosed.
- A check in the amount of \$40.00 to cover the assignment recording fee.
- A duplicate copy of this sheet is enclosed.
- Applicant claims small entity status. See 37 CFR 1.27**


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CERTIFICATE OF MAILING BY "EXPRESS MAIL"

Docket No. : **JCLA7749**
Applicant(s) : **James Seng-Ju Ni**
For : **CIRCUIT TRIMMING OF PACKAGED IC CHIP**
"Express Mail" : **EL 857833502 US**
Mailing Label No.

Date of Deposit : *November 21, 2001*

I hereby certify that the accompanying

Transmittal in Duplicate; Specification 14 pages, 3 sheets of drawings; **SIGNED** Declaration and Power of Attorney 2 pages; Recordation Form Cover Sheet and Assignment 3 pages; Checks for Filing Fee(s); Return Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and are addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

m. Chang

Michelle Chang